

# HEXFRED® Ultrafast Diodes, 100 A (INT-A-PAK Power Modules)



PRIMARY CHARACTERISTICS				
$V_{R}$	1200 V			
V <sub>F</sub> (typical)	2.5 V			
t <sub>rr</sub> (typical)	150 ns			
I <sub>F(DC)</sub> at T <sub>C</sub>	110 A at 100 °C			
Package	INT-A-PAK			
Circuit configuration	Two diodes doubler circuit			

#### **FEATURES**





- Standard JEDEC® package
- · Simplified mechanical designs, rapid assembly
- High surge capability
- Large creepage distances
- UL approved file E78996
  - ved lile E70990
- Case style INT-A-PAK
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V <sub>R</sub>		1200	V	
Continuous forward current		T <sub>C</sub> = 25 °C	205		
	IF	T <sub>C</sub> = 100 °C	110	Α	
Single pulse forward current	I <sub>FSM</sub>	Limited by junction temperature	800		
Maximum power dissipation	Б	T <sub>C</sub> = 25 °C	695	W	
	P <sub>D</sub>	T <sub>C</sub> = 100 °C	280		
RMS isolation voltage	V <sub>ISOL</sub>	50 Hz, circuit to base, all terminal shorted, t = 1 s	3500	V	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-40 to +150	°C	

<b>ELECTRICAL SPECIFICATIONS PER LEG</b> (T <sub>J</sub> = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	$V_{BR}$	Ι <sub>R</sub> = 100 μΑ	1200	-	-	
Maximum forward voltage V <sub>FM</sub>	V	I <sub>F</sub> = 100 A	-	2.5	3.2	V
	I <sub>F</sub> = 160 A	-	2.9	3.9		
Maximum reverse leakage current	I <sub>RM</sub>	T <sub>J</sub> = 150 °C, V <sub>R</sub> = 1200 V	-	18	30	mA



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	150	200	ns
Reverse recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C	$I_F = 160 \text{ A}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$	-	20	22	Α
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C	$V_{\rm R} = 200 \text{ V}$	-	2000	2400	nC
Peak rate of recovery current	dI <sub>(rec)M</sub> /dt	T <sub>J</sub> = 25 °C		-	-	300	A/µs

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS
Junction operating and storage temperature range		T <sub>J</sub> , T <sub>Stg</sub>		-40 to +150	°C
Maximum internal thermal res junction to case per leg	sistance,	$R_{thJC}$	DC operation	0.18	°C/W
Typical thermal resistance, case to heatsink per module		R <sub>thCS</sub>	Mounting surface flat, smooth and greased	0.05	C/VV
Mounting torque ± 10 % —	to heatsink busbar		A mounting compound is recommended and the torque should be rechecked after a period of 3 hours	4 to 6	Nm
Approximate weight	Dusbai		to allow for the spread of the compound.	200	g
Approximate weight				7.1	OZ.
Case style			INT-A	-PAK	

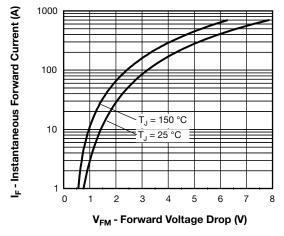


Fig. 1 - Maximum Forward Voltage Drop Characteristics

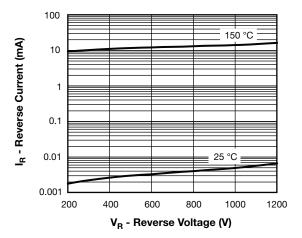


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

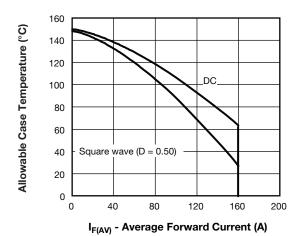


Fig. 3 - Maximum Allowable Case Temperature vs. Average Forward Current

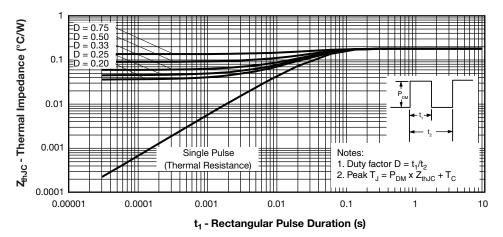


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

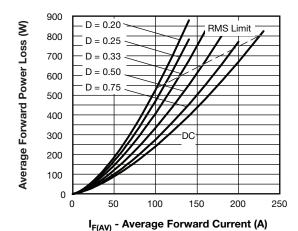


Fig. 5 - Forward Power Loss Characteristics

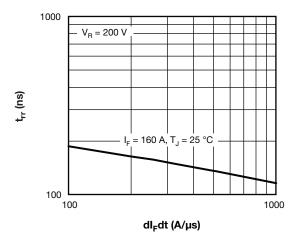


Fig. 6 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt (Per Leg)

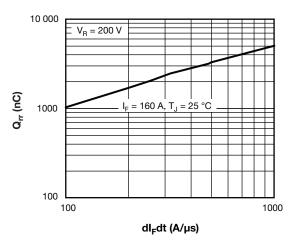


Fig. 7 - Typical Reverse Recovery Charge vs. dl<sub>F</sub>/dt (Per Leg)

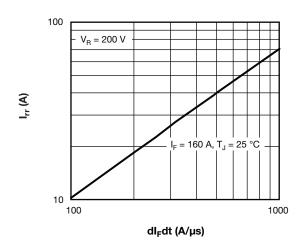
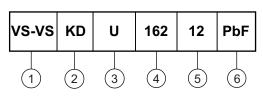


Fig. 8 - Typical Reverse Recovery Current vs. dl<sub>F</sub>/dt (Per Leg)

#### **ORDERING INFORMATION TABLE**

Device code



1 - Vishay Semiconductors product

2 - Circuit configuration

3 - U = HEXFRED® ultrafast diode

4 - Current rating

5 - Voltage rating (12 = 1200 V)

6 - PbF = Lead (Pb)-free

#### **CIRCUIT CONFIGURATION**

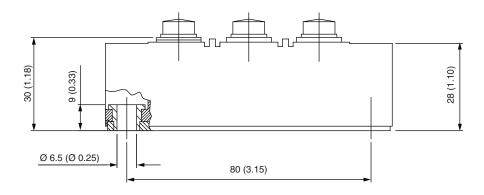


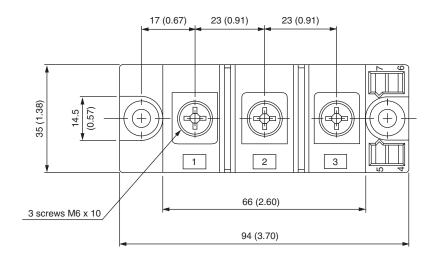
LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95254				

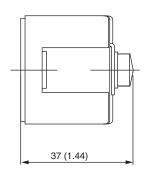


## **INT-A-PAK DBC**

#### **DIMENSIONS** in millimeters (inches)







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